

2MBI300VD-120-50

IGBT Modules

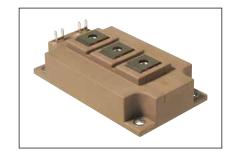
IGBT MODULE (V series) 1200V / 300A / 2 in one package

Features

High speed switching Voltage drive Low Inductance module structure

Applications

Inverter for Motor Drive AC and DC Servo Drive Amplifier Uninterruptible Power Supply Industrial machines, such as Welding machines



Maximum Ratings and Characteristics

■ Absolute Maximum Ratings (at Tc=25°C unless otherwise specified)

Items	Symbols	Conditions	Conditions		Units
Collector-Emitter voltage	Vces				V
Gate-Emitter voltage	V _{GES}			±20	V
_	lo.	Continuous	Tc=100°C	300	
rte	Ic	Continuous	Tc=25°C	360	
Collector current	Ic pulse	1ms		600	
드	-lc				
	-lc pulse	1ms	1ms		
Collector power dissipation	Pc	1 device	1 device		W
Junction temperature	Tj			175	
Operating junction temperature (under switching of	conditions) T _{jop}				°C
Case temperature	Tc				C
orage temperature Tstg				-40 ~ +125	
Isolation voltage between terminal and copper	base (*1) V _{iso}	AC: 1min.	AC : 1min.		VAC
Serous torque Mounting (*2)					N m
Screw torque Terminals (*3)					IN III

Note *1: All terminals should be connected together during the test. Note *2: Recommendable Value : 3.0-6.0 Nm (M5 or M6) Note *3: Recommendable Value : 2.5-5.0 Nm (M6)

● Electrical characteristics (at Tj= 25°C unless otherwise specified)

ems	Cumbala	Complete Conditions			Characteristics		11-14-
ems	Symbols	Conditions		min.	typ.	max.	Units
Zero gate voltage collector current	Ices	V _{GE} = 0V, V _{CE} = 1200V		-	-	2.0	mA
Gate-Emitter leakage current	Iges	$V_{CE} = 0V, V_{GE} = \pm 20V$		-	-	400	nA
Gate-Emitter threshold voltage	V _{GE (th)}	V _{CE} = 20V, I _C = 300mA		6.0	6.5	7.0	V
		V _{GE} = 15V I _C = 300A	Tj=25°C	-	2.00	2.45	V
Collector-Emitter saturation voltage	V _{CE (sat)}		Tj=125°C	-	2.35	-	
	(terminal)		Tj=150°C	-	2.40	-	
	V		Tj=25°C	-	1.85	2.10	
	V _{CE} (sat)		Tj=125°C	-	2.15	-	
	(chip)		Tj=150°C	-	2.20	-	
Internal gate resistance	R _{g(int)}	-		-	2.5	-	Ω
Input capacitance	Cies	$V_{CE} = 10V, V_{GE} = 0V, f = 1MHz$		-	24.0	-	nF
Input capacitance Turn-on time	ton	V _{cc} = 600V, I _c = 300A V _{GE} = ±15V, R _G = 1.8Ω Tj = 150°C, Ls =30nH		-	0.60	-	µsec
	tr			-	0.20	-	
	tr (i)			-	0.05	-	
Turn-off time	toff			-	0.80	-	
	tf			-	0.08	-	
Forward on voltage	VF	V _{GE} = 0V I _F = 300A	Tj=25°C	-	1.85	2.25	V
	(terminal)		Tj=125°C	-	2.00	-	
	(terrillial)		Tj=150°C	-	1.95	-	
	V _F (chip)		Tj=25°C	-	1.70	1.95	
			Tj=125°C	-	1.85	-	
	(Criip)		Tj=150°C	-	1.80	-	
Reverse recovery time	trr	I _F = 300A	·	-	0.15	-	usec

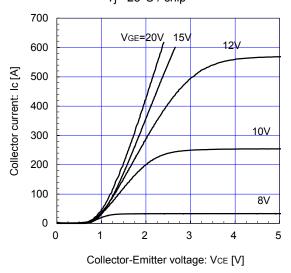
■ Thermal resistance characteristics

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Items	Symbols	Conditions	Characteristics			Units
items			min.	typ.	max.	Ullits
Thermal resistance (1device)	Dth/i o)	IGBT	-	-	0.068	°C/W
	Rth(j-c)	FWD		-	0.110	
Contact thermal resistance (1device) (*4)	Rth(c-f)	with Thermal Compound	-	0.0125	-	

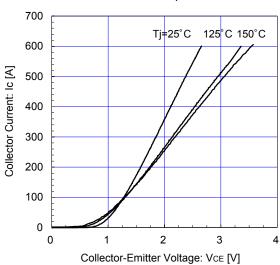
Note *4: This is the value which is defined mounting on the additional cooling fin with thermal compound.

■ Characteristics (Representative)

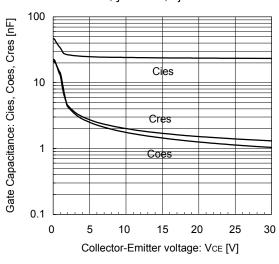
Collector current vs. Collector-Emitter voltage (typ.) Tj= 25°C / chip



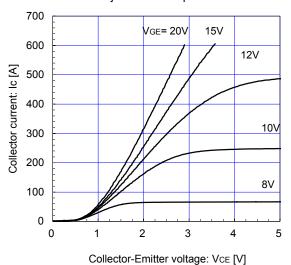
Collector current vs. Collector-Emitter voltage (typ.) VGE= 15V / chip



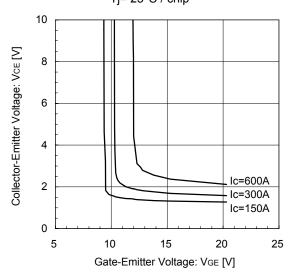
Gate Capacitance vs. Collector-Emitter Voltage VGE= 0V, f= 1MHz, Tj= 25°C



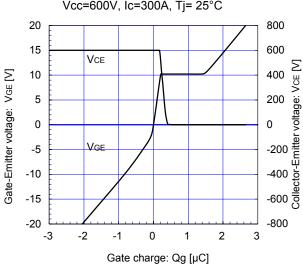
Collector current vs. Collector-Emitter voltage (typ.) Tj= 150°C / chip



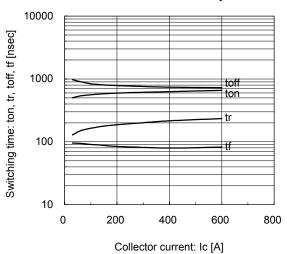
Collector-Emitter voltage vs. Gate-Emitter voltage Tj= 25°C / chip



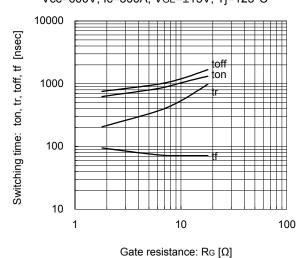
Dynamic Gate Charge (typ.) Vcc=600V, Ic=300A, Tj= 25°C



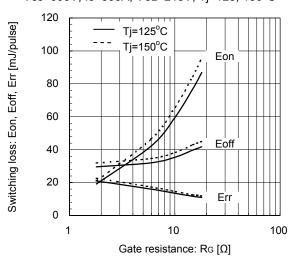
Switching time vs. Collector current (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1.8\Omega$, $Tj=125^{\circ}C$



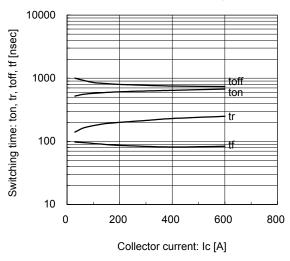
Switching time vs. Gate resistance (typ.) Vcc=600V, Ic=300A, VGE=±15V, Tj=125°C



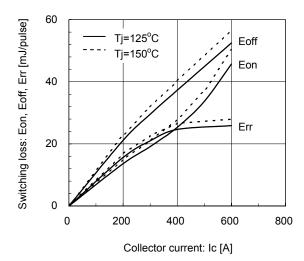
Switching loss vs. Gate resistance (typ.) Vcc=600V, Ic=300A, VgE=±15V, Tj=125, 150°C



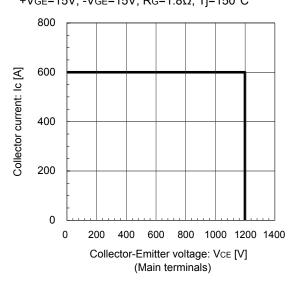
Switching time vs. Collector current (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1.8\Omega$, $Tj=150^{\circ}C$



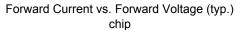
Switching loss vs. Collector current (typ.) Vcc=600V, VgE= \pm 15V, Rg=1.8 Ω , Tj=125, 150°C

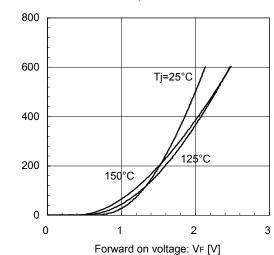


Reverse bias safe operating area (max.) +V_{GE}=15V, -V_{GE}=15V, R_G=1.8 Ω , Tj=150°C

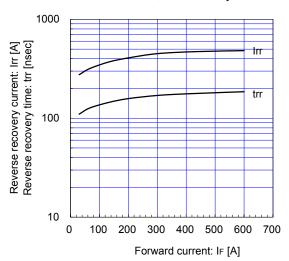


Forward current: IF [A]

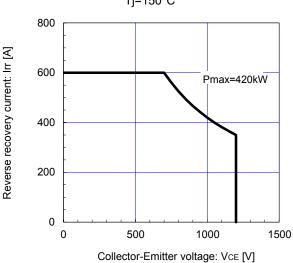




Reverse Recovery Characteristics (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1.8\Omega$, $Tj=150^{\circ}C$

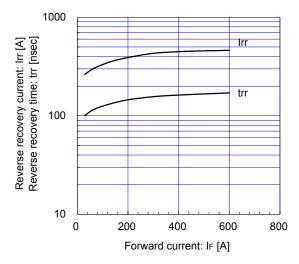


FWD safe operating area (max.) Tj=150°C

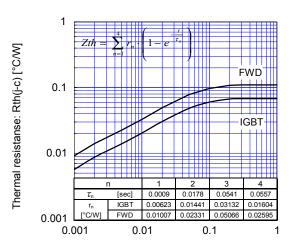


(Main terminals)

Reverse Recovery Characteristics (typ.) Vcc=600V, $VgE=\pm15V$, $Rg=1.8\Omega$, $Tj=125^{\circ}C$



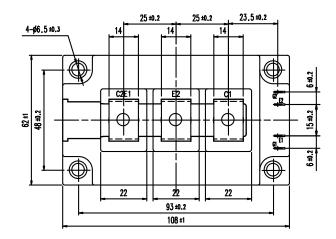
Transient Thermal Resistance (max.)

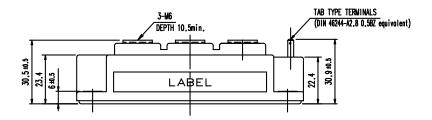


Pulse Width: Pw [sec]

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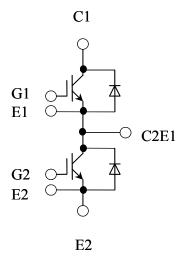
■ Outline Drawings (Unit: mm)





Weight: 370g (typ.)

■ Equivalent Circuit



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IGBT Modules

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